TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π –MOS VI)

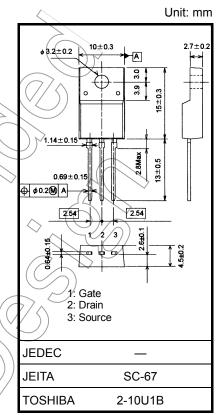
2SK4015

Switching Regulator Applications

- Low drain-source ON-resistance: R_{DS} (ON) = 0.60 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 7.4 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (V_{DS} = 600 V)
- Enhancement model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	600	(γ)
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	600	(\mathbf{v})
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	Ι _D	10	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	40	√ А
Drain power dissipation (Tc = 25° C)		PD	45	W
Single-pulse avalanche energy (Note 2)		EAS	363	mJ
Avalanche current		IAR	10	A
Repetitive avalanche energy (Note 3)		EAR	4.5	mJ
Channel temperature			150	°C
Storage temperature range		Tstg	-55 to 150	2%
	(($// \wedge$		



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

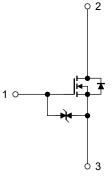
Thermal Characteristics

Characteristic	Symbol	Мах	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 6.36 mH, I_{AR} = 10 A, R_G = 25 Ω

This transistor is an electrostatic-sensitive device. Handle with care.



Note 3: Repetitive rating: pulse width limited by maximum channel temperature

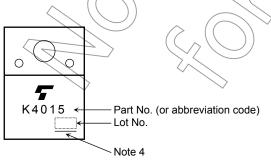
Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$	_	_	±10	μA
Gate-source brea	akdown voltage	V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30		_	V
Drain cutoff curre	ent	I _{DSS}	V_{DS} = 600 V, V_{GS} = 0 V \langle	Ľ		100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	600			V
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0)~	4.0	V
Drain-source ON	-resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.60	0.86	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 V, I_D = 5 A$	3.7	7.4		S
Input capacitance	9	C _{iss}			1500		
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 V$, $V_{GS} = 0 V$, f = 1 MHz	_	15		pF
Output capacitance		C _{oss}			180		
Switching time	Rise time	tr	V_{GS}		22	>	
	Turn-on time	t _{on}	$\begin{array}{c} 0 \\ 0 \\ 50 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 $		50) —	20
	Fall time	t _f	$\begin{array}{c} 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 $		36		ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _W = 10 µs		180		
Total gate charge	9	Qg) —	42		
Gate-source cha	rge	Q _{gs}	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		23		nC
Gate-drain charge Q _{gd}		Qgd			19		

Source-Drain Ratings and Characteristics (Ta = 25° C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1))) I _{DR}		_	_	10	Α
Pulse drain reverse current (Note 1)	IDRP	$(\langle / \rangle) -$	_	_	40	А
Forward voltage (diode)	V _{DSF}	1 _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	trr	I _{DR} = 10 A, V _{GS} = 0 V,	_	170	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/µs		0.6	_	μC

Marking

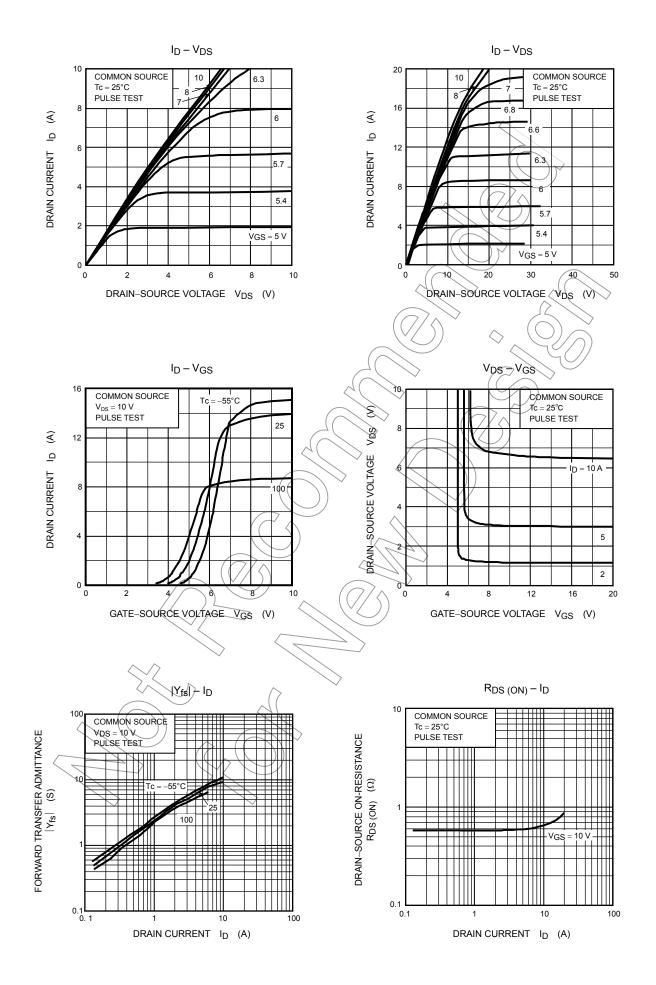


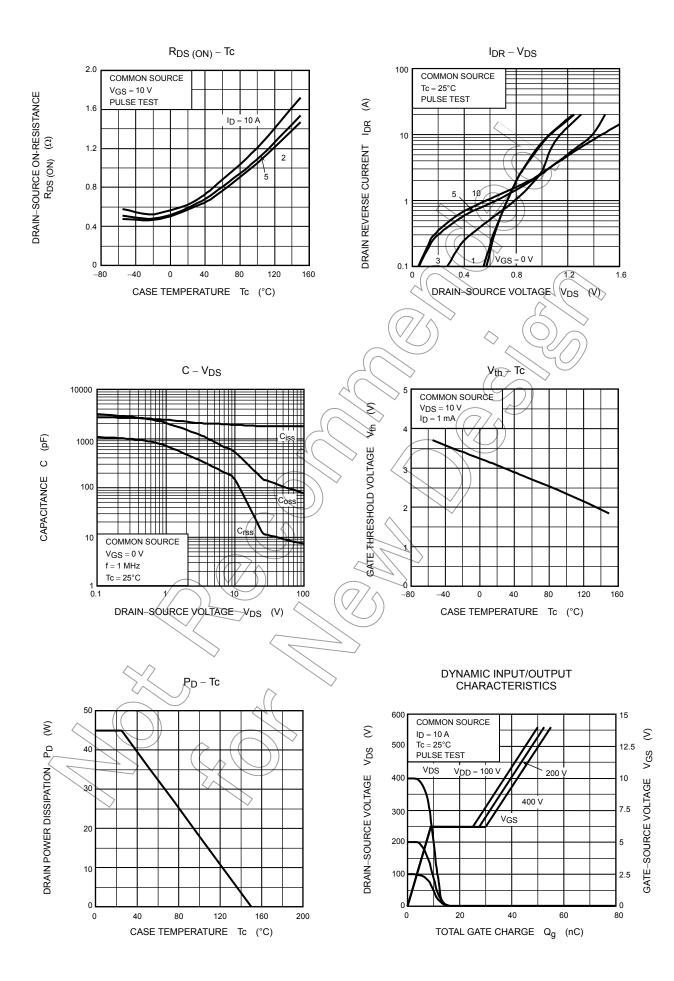
Note 4: A line under a Lot No. identifies the indication of product Labels.

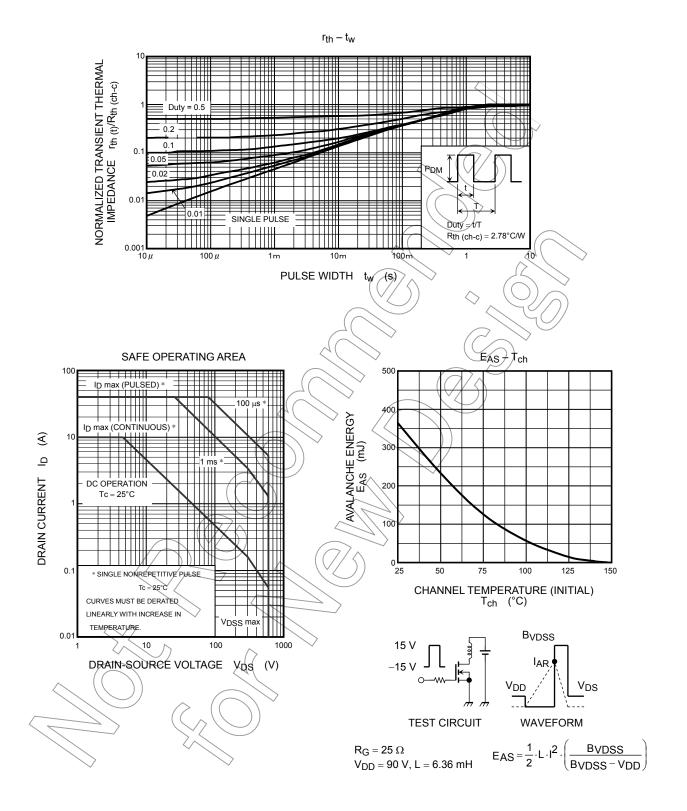
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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